

**PATENT ASSIGNMENT**

Electronic Version v1.1  
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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Sung Min KIM	10/21/2010
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	Hynix Semiconductor Inc.
<b>Street Address:</b>	San 136-1, Ami-ri, Bubal-eup
<b>City:</b>	Icheon-si Gyeonggi-do
<b>State/Country:</b>	REPUBLIC OF KOREA
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	12981207
<b>CORRESPONDENCE DATA</b>	
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<b>ATTORNEY DOCKET NUMBER:</b>	PA0066-0
<b>NAME OF SUBMITTER:</b>	Woochoon William Park
<b>Total Attachments: 2</b> source=PA0066-0_Assignment#page1.tif source=PA0066-0_Assignment#page2.tif	

OP \$40.00 12981207

DOCKET:

PATENT

**ASSIGNMENT OF APPLICATION**

Now, therefore, in consideration of the sum of one dollar (\$1), the receipt whereof is acknowledge, and other good and valuable consideration, I/We, the assignor(s)

**ASSIGNOR(S)**

Sung Min KIM  
101, Seocho Apt., 1357-25, Seocho 2-dong, Seocho-gu, Seoul, Korea

by these presents do sell, assign and transfer unto said assignee

**ASSINGEE**

Hynix Semiconductor Inc.  
San 136-1, Ami-ri, Bubal-eup,  
Icheon-si, Gyeonggi-do, Republic of Korea

and the heirs, successors, assigns and legal representatives of the assignee the full and exclusive right to the said invention in the United States which are disclosed in the U.S. patent application titled:

**SEMICONDUCTOR CHIP WITH CONDUCTIVE DIFFUSION REGIONS,  
METHOD FOR MANUFACTURING THE SAME, AND STACK PACKAGE  
USING THE SAME**

for which an application for a United States Patent was filed on \_\_\_\_\_  
Application Number \_\_\_\_\_; or

for which an application for a United States Patent was executed by the undersigned on \_\_\_\_\_

and any and all improvements thereof, the entire rights, title and interest in and to any and all Patents which may be granted therefore in the United States. I/We hereby authorize and request the Director of the U.S. Patent and Trademark Office to issue said United States Patent to said assignee, of the entire right, title, and interest in and to the same, for his sole use and for the use of his legal representatives, to the full end of the term for which said Patent may be granted, as fully and entirely as the same would have been held by me had this assignment and sale not been made.

The assignor(s) agree promptly upon request of the Assignee, its heirs, successors, assigns and legal representatives of the assignee to communicate any facts known to it respecting the patent and the invention set forth therein, and to execute and deliver without further compensation any power of attorney,



